GaAs MMICs Panasonic

GN01061B

GaAs IC (with built-in ferroelectric)

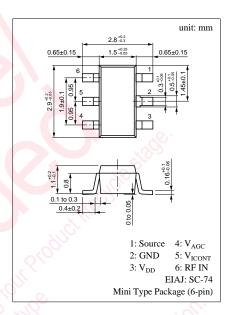
Low-noise amplifier for CDMA

■ Features

- Gain control amplifier
- High-gain
- Low consumption current

■ Absolute Maximum Ratings (Ta = 25°C)

Parameter	Symbol	Ratings	Unit	
Power supply voltage	V _{DD}	8	V	
Gate control voltage	V _{AGC}	0 to 3	V	
	V _{ICONT}	0 to 3	V	
Circuit current	I_{DD}	20	mA	
Max input power	P _{in}	-5	dBm	
Allowable power dissipation	P _D	200	mW	
Operating ambient temperature	Topr	-30 to +90	°CO	
Storage temperature	T _{stg}	-40 to +120	°C	
			~	



■ Electrical Characteristics ($V_{DD} = 2.9V$, $P_{in} = -30$ dBm, f = 850MHz, $Ta = 25 \pm 3$ °C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Circuit current	I_{DD}^{*1}	$V_{AGC} = 1.2V$, $V_{ICONT} = 2.9V$	2, 2	2 4	5.5	mA
Power gain	PG*1	$V_{AGC} = 1.2V, V_{ICONT} = 2.9V$	14	16.5	19	dB
Noise figure	NF*1, 3	$V_{AGC} = 1.2V, V_{ICONT} = 2.9V$	o'll'	1.1	2	dB
Dynamic range	DR*1	$V_{AGC} = 0.2 \text{ to } 1.2V, V_{ICONT} = 2.9V$	18	22		dB
Input return loss	S11*1, 3	$V_{AGC} = 1.2V$, $V_{ICONT} = 2.9V$		-10	-6	dB
Output return loss	S22*1, 3	$V_{AGC} = 1.2V, V_{ICONT} = 2.9V$		-15	-10	dB
Third input intersept point	IIP3*1, 2	$V_{AGC} = 1.2V, V_{ICONT} = 2.9V$	-4	-3		dBm
Third output intersept point	OIP3*1, 2	$V_{AGC} = 0.2 \text{ to } 1.2 \text{V}, V_{ICONT} = 2.9 \text{V}$	10			dBm

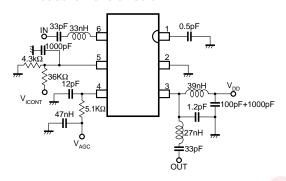
^{*1} Refer to measurement circuit.

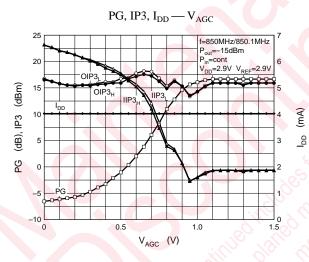
 $^{^{*2}\} Sampling\ guaranteed\ items.\ (AQL:\ Measurement\ on\ the\ 2-tone\ (850MHz-30dBm/850.1MHz-30dBm))$

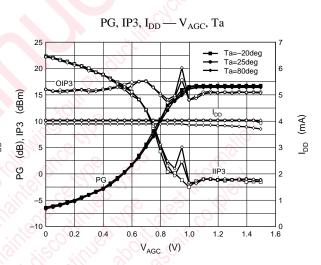
^{*3} Design-guaranteed items.

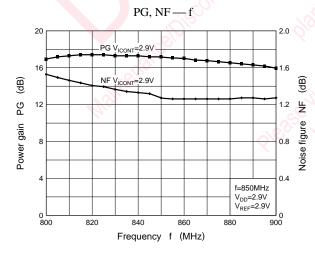
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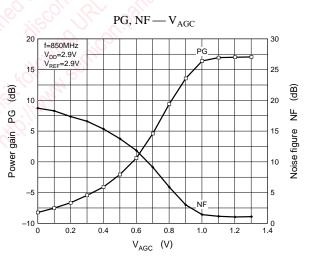
■ Measurement Circuit











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■ This product contains Gallium Arsenide (GaAs).

GaAs powder and vapor are hazardous to human health if inhaled or ingested. Do not burn, destroy, cut, cleave off, or chemically dissolve the product. Follow related laws and ordinances for disposal. The product should be excluded from general industrial waste or household garbage.

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